

TPCA8015-H

High-Efficiency DC/DC Converter Applications

- Small footprint due to small and thin package
- High-speed switching
- Small gate charge: $Q_{sw} = 13 \text{ nC (typ.)}$
- Low drain-source ON-resistance: $R_{DS(ON)} = 4.4 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: $|Y_{fs}| = 60 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 10 \text{ }\mu\text{A (max) (}V_{DS} = 40 \text{ V)}$
- Enhancement mode: $V_{th} = 1.1 \text{ to } 2.3 \text{ V (}V_{DS} = 10 \text{ V, } I_D = 1 \text{ mA)}$

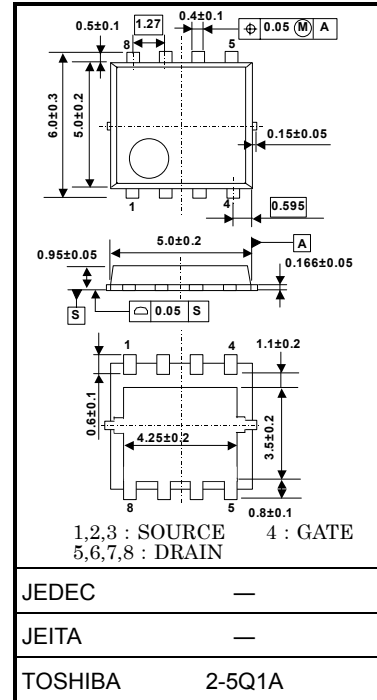
Maximum Ratings ($T_a = 25^\circ\text{C}$)

| Characteristic | | Symbol | Rating | Unit |
|---|-----------------|-----------|------------|------------------|
| Drain-source voltage | | V_{DSS} | 40 | V |
| Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$) | | V_{DGR} | 40 | V |
| Gate-source voltage | | V_{GSS} | ± 20 | V |
| Drain current | DC (Note 1) | I_D | 35 | A |
| | Pulsed (Note 1) | I_{DP} | 105 | |
| Drain power dissipation ($T_c = 25^\circ\text{C}$) | | P_D | 45 | W |
| Drain power dissipation ($t = 10 \text{ s}$) (Note 2a) | | P_D | 2.8 | W |
| Drain power dissipation ($t = 10 \text{ s}$) (Note 2b) | | P_D | 1.6 | W |
| Single-pulse avalanche energy (Note 3) | | E_{AS} | 114 | mJ |
| Avalanche current | | I_{AR} | 35 | A |
| Repetitive avalanche energy ($T_c = 25^\circ\text{C}$) (Note 4) | | E_{AR} | 2.7 | mJ |
| Channel temperature | | T_{ch} | 150 | $^\circ\text{C}$ |
| Storage temperature range | | T_{stg} | -55 to 150 | $^\circ\text{C}$ |

Note: For Notes 1 to 5, refer to the next page.

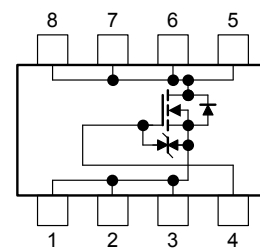
This transistor is an electrostatic-sensitive device. Handle with care.

Unit: mm



Weight: 0.067 g (typ.)

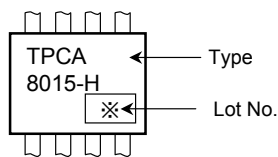
Circuit Configuration



Thermal Characteristics

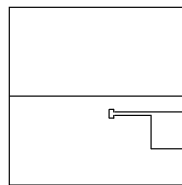
| Characteristic | Symbol | Max | Unit |
|---|----------------|------|--------------------|
| Thermal resistance, channel to case ($T_c=25^\circ\text{C}$) | $R_{th(ch-c)}$ | 2.78 | $^\circ\text{C/W}$ |
| Thermal resistance, channel to ambient ($t = 10\text{ s}$) (Note 2a) | $R_{th(ch-a)}$ | 44.6 | $^\circ\text{C/W}$ |
| Thermal resistance, channel to ambient ($t = 10\text{ s}$) (Note 2b) | $R_{th(ch-a)}$ | 78.1 | $^\circ\text{C/W}$ |

Marking (Note 5)



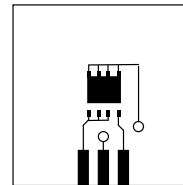
Note 1: The channel temperature should not exceed 150°C during use.

Note 2: (a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



FR-4
 $25.4 \times 25.4 \times 0.8$
 (Unit: mm)

(a)



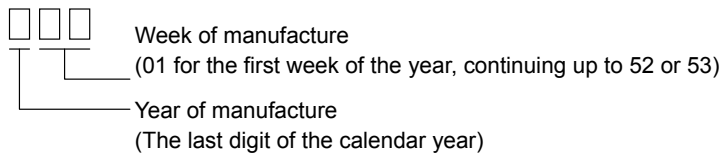
FR-4
 $25.4 \times 25.4 \times 0.8$
 (Unit: mm)

(b)

Note 3: $V_{DD} = 24\text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 0.1\text{ mH}$, $R_G = 25\ \Omega$, $I_{AR} = 35\text{ A}$

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: * Weekly code: (Three digits)

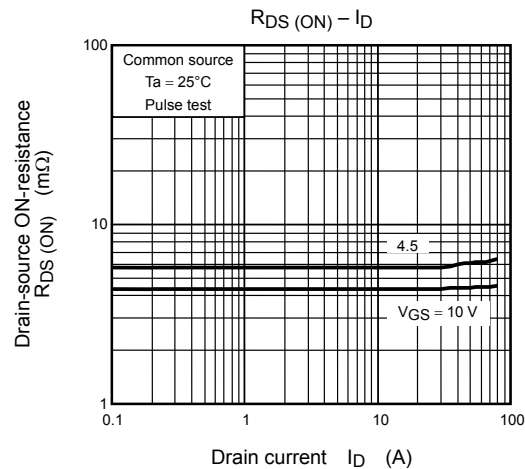
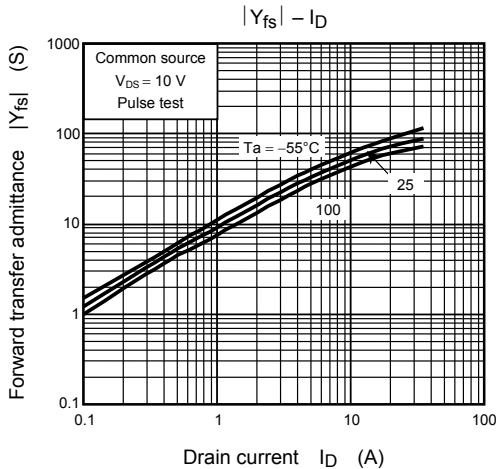
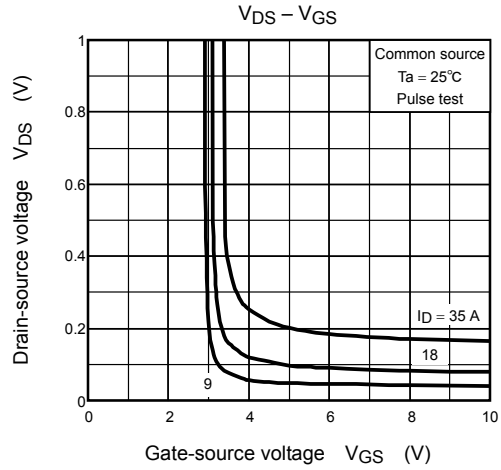
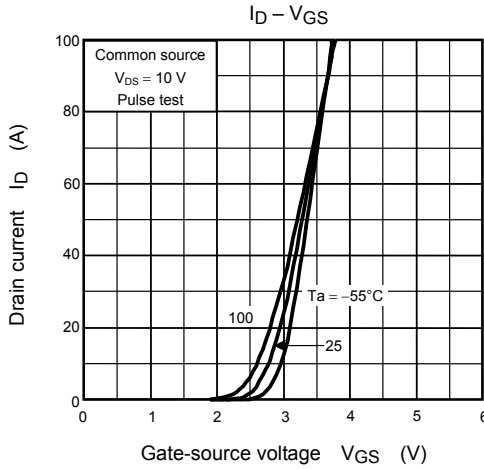
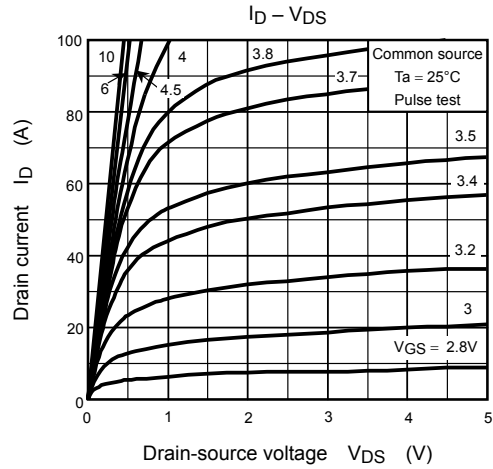
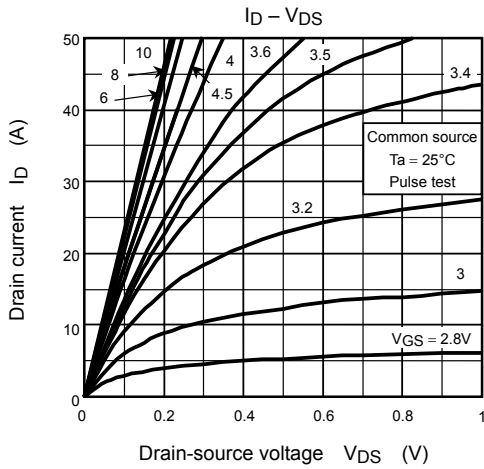


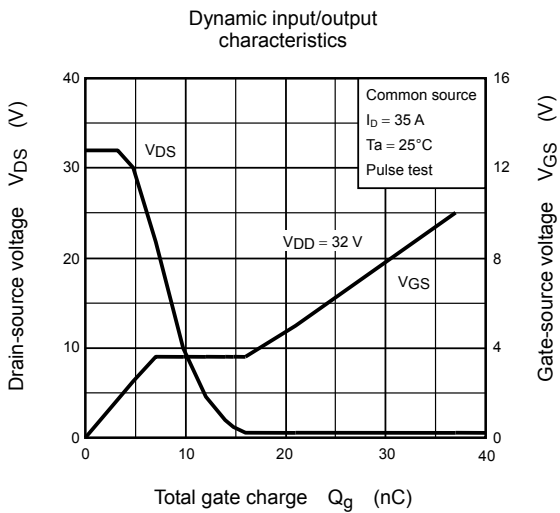
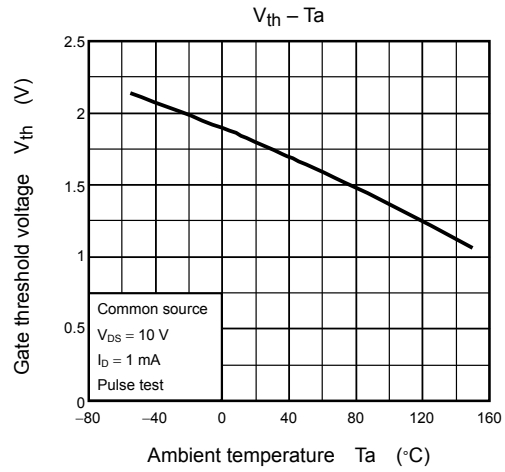
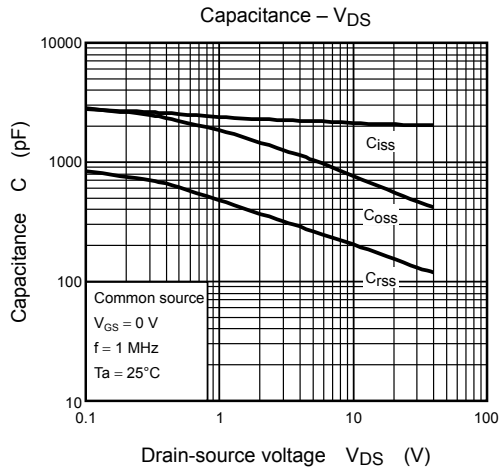
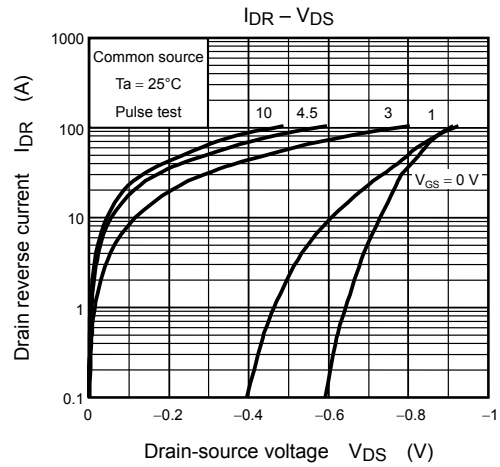
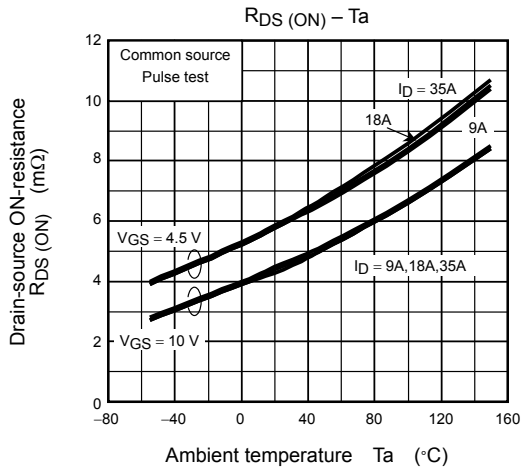
Electrical Characteristics (Ta = 25°C)

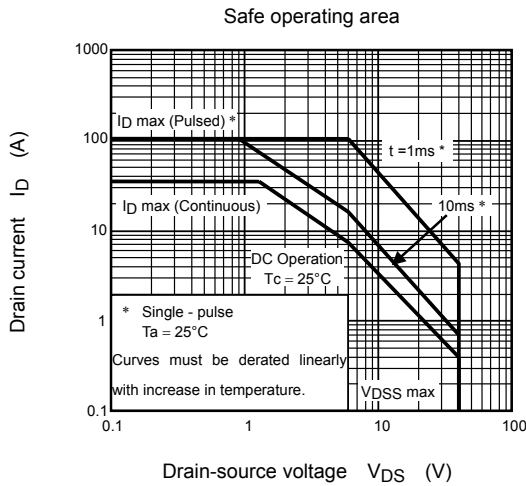
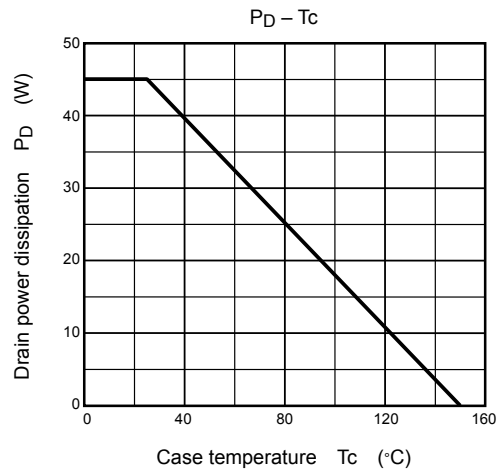
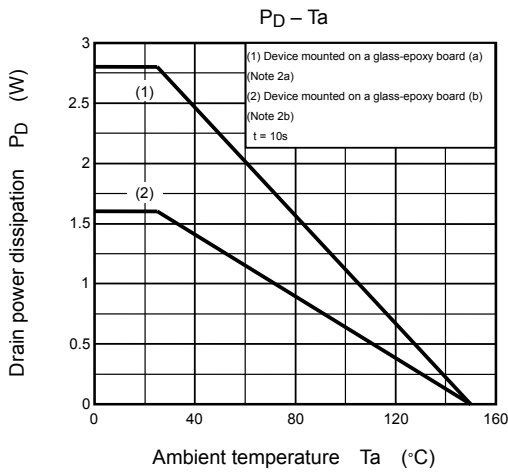
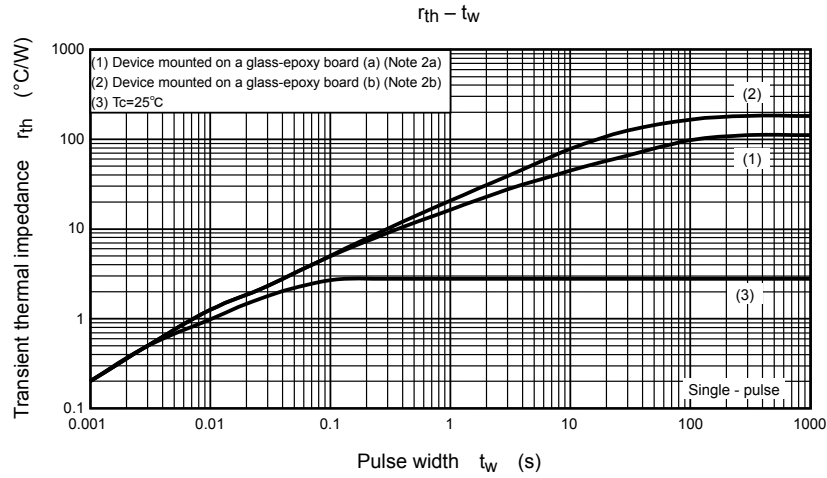
| Characteristic | | Symbol | Test Condition | Min | Typ. | Max | Unit |
|---|---------------|---------------|--|-----|------|----------|------------------|
| Gate leakage current | | I_{GSS} | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$ | — | — | ± 10 | μA |
| Drain cutoff current | | I_{DSS} | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$ | — | — | 10 | μA |
| Drain-source breakdown voltage | | $V_{(BR)DSS}$ | $I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$ | 40 | — | — | V |
| | | $V_{(BR)DSX}$ | $I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$ | 25 | — | — | |
| Gate threshold voltage | | V_{th} | $V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$ | 1.1 | — | 2.3 | V |
| Drain-source ON-resistance | | $R_{DS(ON)}$ | $V_{GS} = 10 \text{ V}, I_D = 17.5 \text{ A}$ | — | 4.4 | 5.4 | $\text{m}\Omega$ |
| | | | $V_{GS} = 4.5 \text{ V}, I_D = 17.5 \text{ A}$ | — | 6.1 | 7.9 | |
| Forward transfer admittance | | $ Y_{fs} $ | $V_{DS} = 10 \text{ V}, I_D = 17.5 \text{ A}$ | 30 | 60 | — | S |
| Input capacitance | | C_{iss} | $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | — | 2155 | — | pF |
| Reverse transfer capacitance | | C_{rss} | | — | 200 | — | |
| Output capacitance | | C_{oss} | | — | 780 | — | |
| Gate resistance | | R_g | | — | 1.4 | — | |
| Switching time | Rise time | t_r | <p>$V_{GS} = 10 \text{ V}$ 0 V $I_D = 17.5 \text{ A}$ V_{OUT} 4.7Ω $R_L = 1.1 \Omega$ $V_{DD} \approx 20 \text{ V}$ Duty $\leq 1\%$, $t_w = 10 \mu\text{s}$</p> | — | 5 | — | ns |
| | Turn-on time | t_{on} | | — | 12 | — | |
| | Fall time | t_f | | — | 10 | — | |
| | Turn-off time | t_{off} | | — | 48 | — | |
| Total gate charge (gate-source plus gate-drain) | | Q_g | $V_{DD} \approx 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 35 \text{ A}$ | — | 37 | — | nC |
| | | | $V_{DD} \approx 32 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 35 \text{ A}$ | — | 21 | — | |
| Gate-source charge 1 | | Q_{gs1} | $V_{DD} \approx 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 35 \text{ A}$ | — | 7 | — | |
| Gate-drain ("Miller") charge | | Q_{gd} | $V_{DD} \approx 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 35 \text{ A}$ | — | 9 | — | |
| Gate switch charge | | Q_{SW} | $V_{DD} \approx 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 35 \text{ A}$ | — | 13 | — | |

Source-Drain Ratings and Characteristics (Ta = 25°C)

| Characteristic | | Symbol | Test Condition | Min | Typ. | Max | Unit |
|-------------------------|----------------|-----------|---|-----|------|------|------|
| Drain reverse current | Pulse (Note 1) | I_{DRP} | — | — | — | 105 | A |
| Forward voltage (diode) | | V_{DSF} | $I_{DR} = 35 \text{ A}, V_{GS} = 0 \text{ V}$ | — | — | -1.2 | V |







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20070701-EN

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